

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHAO PANG	08/10/2022
LINGYUN MI	08/10/2022
BIN QIN	08/10/2022
CHAOYUAN CHAN	08/10/2022
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17954506
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NAME OF SUBMITTER:	THUY-KIM T. NGUYEN
SIGNATURE:	/Thuy-Kim T. Nguyen/
DATE SIGNED:	09/28/2022
Total Attachments: 2	
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COMBINED DECLARATION & ASSIGNMENT	Page 1 of 2
	Title: PHOTOSENSITIVE ASSEMBLY, CAMERA MODULE AND ELECTRONIC DEVICE

ASSIGNMENT

WHEREAS, we, **PANG, Chao, MI, Lingyun, QIN, Bin and CHAN, Chaoyuan** have invented certain new and useful improvements as described in U.S. patent application, entitled

PHOTOSENSITIVE ASSEMBLY, CAMERA MODULE AND ELECTRONIC DEVICE

, the application having been executed on even date herewith, and/or being identified in the United States Patent and Trademark Office ("USPTO") by Application No. _____, filed _____ ("Invention"); and

WHEREAS, **Guangzhou Luxvisions Innovation Technology Limited**, a Corporation of the People's Republic of China, and having an address of No. 25 Guangpu West Road, Science City, Guangzhou Hi-tech Industrial Development Zone 510663, the People's Republic of China (together with its successors and assigns, the "Assignee"), seeks to memorialize its ownership of the entire right, title and interest in and to the Invention;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt and adequacy of which are hereby acknowledged, I transfer to Assignee my entire right, title, and interest in and to the Invention, including all inventions disclosed or claimed in the above-identified patent application, including any improvements thereof, any corresponding domestic applications (e.g., provisional, non-provisional, divisional, continuation, continuation-in-part, reexamination, and/or reissue patent), any corresponding foreign applications, all patents issuing thereon, or other patent application based off or claiming priority to the above-identified patent application, and all rights and benefits under any applicable treaty or convention. I authorize the USPTO (or foreign equivalent thereof) to issue any patent (or similar legal protection) to the Assignee.

I authorize the Assignee to insert in this instrument the filing date and application number of the application when ascertained. I hereby authorize the Assignee (or its designee) to apply for patent (or similar legal protection) in its own name if desired, in any and all countries.

I represent to the Assignee that I have not and shall not execute any writing or do any act whatsoever conflicting with this Assignment. I agree when requested, without additional consideration, but at the expense of the Assignee, to provide additional reasonable assistance necessary to memorialize this assignment, to execute all oaths, declarations, assignments, powers of attorney and other papers necessary to perfect and vest title to the rights assigned herein to the Assignee; and will render all assistance in filing, obtaining, maintaining, and enforcing any patent (or similar legal protection) on the Invention in any and all countries.

DECLARATION

I have reviewed and understand the contents of the above-identified patent application including the claims, and I believe I am an original or an original joint inventor of a claimed invention in the above-identified patent application. The above-identified patent application was made or authorized to be made by me. I am aware of and acknowledge my duty to disclose to the USPTO all information known to me to be material to patentability of the claims in the above-identified patent application. I acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

PANG, Chao

Date PANG Chao

2022.08.10

MI, Lingyun

Date MI Lingyun

2022.08.10

**COMBINED DECLARATION
& ASSIGNMENT**

Title: PHOTSENSITIVE ASSEMBLY,
CAMERA MODULE AND
ELECTRONIC DEVICE

Bin. Qin
QIN, Bin

Date 2022/08/10

CHAN. Chaoyuan
CHAN, Chaoyuan

Date 2022/08/10